

APPROVAL SHEET

AOT MODEL NAME	3014M
AOT PART NUMBER	3014M-W3M2
CUSTOMER NAME	General Customer
DATE	2021/Oct.
VERSION	01

MAKER			CUST	OMER	
Prepared Checked Approved					

AOT Headquarters

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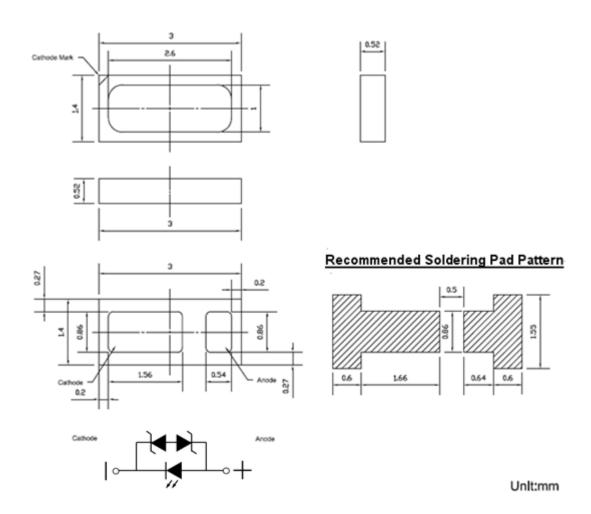
Revision Note

Date	Revision	Page	Version
2021-10-15	Initiate Document	18	01



Package Outline

Model name: 3014M-W3M2 Unit: mm, Tolerance: ± 0.2 mm



Item	Materials
Package	Heat-Resistant Polymer
Encapsulating Material	Silicone(with phosphor)
Electrode	Ag Plating Copper Alloy

- Single blue chip.
- High brightness SMD.
- Compact package outline (LxWxH) of 3.0 mm x 1.4 mm x 0.52 mm.
- · Compatible with reflow soldering.
- Complies with RoHS Directive.



Optical/Electronic Characteristics (TA=25°C)

AOT Reading Standards							
Item Symbol Condition Min Typ. Max						Unit	
Forward Voltage	VF	I _F = 60mA	2.8	-	3.4	V	
Luminous Flux	Ф۷	I _F = 60mA	16.9	-	20.8	lm	

^{*} Tolerance of measurements of the Forward Voltage is ± 0.05 V.

Absolute Maximum Ratings (TA=25°C)

Item	Symbol	Absolute Maximum Rating	Unit	
Forward Current	l _F	70	mA	
*Pulse Forward Current	I _{FP}	150	mA	
Power Dissipation	P _D	238	mW	
Reverse Voltage	V _R	5	V	
Operating Temperature	T _{opr}	-40~+85	°C	
Storage Temperature	T _{stg}	-40~+100	°C	
Soldering Temperature	T _{sld}	Reflow Soldering : 260°C for 10sec		
Junction Temperature	Tj	125	°C	
Forward Voltage at Low Current	V _{F2}	>1.9 (@1 μ A)	V	

^{*} I_{FP} Conditions: Pulse Width \leq 10msec, and duty \leq 1/10

^{*} Tolerance of measurements of the Luminous Flux is ± 5%.

^{*} Max condition is not guarantee for life time



Group Definition of Forward Voltage

Rank	Condition	V _F (V)
C3	T _A =25 °C	2.8 ~ 3.1
D3	I⊧=60mA	3.1 ~ 3.4

Group Definition of Brightness

Rank	Condition	AOT Luminous Flux(Im)
Y2015		20.15 ~ 20.80
Y1950	T _A =25°C I _F =60mA	19.50 ~ 20.15
Y1885		18.85 ~ 19.50
Y1820		18.20 ~ 18.85
Y1755		17.55 ~ 18.20
Y1690		16.90 ~ 17.55

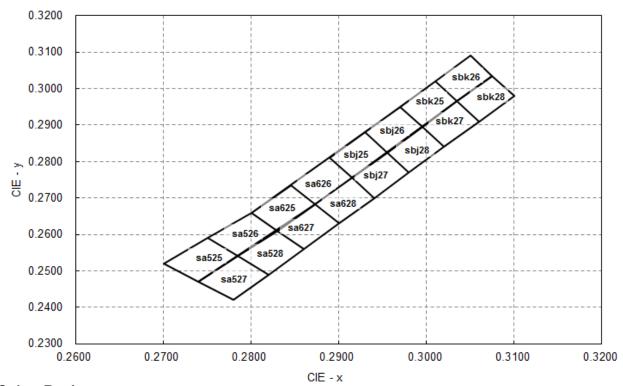
^{*} A shipment shall consist of LEDs in a combination of above ranks.

^{*} The percentage of each rank in the shipment shall be determined by AOT.

^{*} The ranking information of LEDs can be found on the reel label.



Group Definition of Chromaticity Coordinate



Color Rank

Rank	х	у	Rank	х	у	Rank	х	у
	0.2700	0.2520		0.2800	0.2660		0.2890	0.2810
sa525	0.2750	0.2590	005	0.2845	0.2735	ah:OF	0.2930	0.2880
	0.2785	0.2540	sa625	0.2873	0.2683	sbj25	0.2955	0.2825
	0.2740	0.2470		0.2830	0.2610		0.2915	0.2755
	0.2750	0.2590		0.2845	0.2735		0.2930	0.2880
00526	0.2800	0.2660	20606	0.2890	0.2810	ahi06	0.2970	0.2950
sa526	0.2830	0.2610	sa626	0.2915	0.2755	sbj26	0.2995	0.2895
	0.2785	0.2540		0.2873	0.2683		0.2955	0.2825
	0.2740	0.2470		0.2830	0.2610	ob:27	0.2915	0.2755
00F27	0.2785	0.2540		0.2873	0.2683		0.2955	0.2825
sa527	0.2820	0.2490	sa627	0.2900	0.2630	sbj27	0.2980	0.2770
	0.2780	0.2420		0.2860	0.2560		0.2940	0.2700
	0.2785	0.2540		0.2873	0.2683		0.2955	0.2825
sa528	0.2830	0.2610	sa628	0.2915	0.2755	obi20	0.2995	0.2895
5a320	0.2860	0.2560	Sa020	0.2940	0.2700	sbj28	0.3020	0.2840
	0.2820	0.2490		0.2900	0.2630		0.2980	0.2770



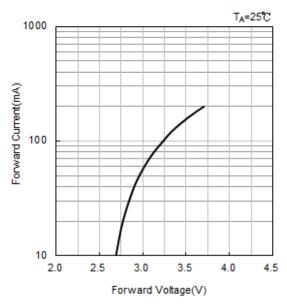
Rank	х	у	Rank	х	у	Rank	х	у
	0.2970	0.2950	ahk20	0.3010	0.3020	-1-1-07	0.2995	0.2895
abl/25	0.3010	0.3020		0.3050	0.3090		0.3035	0.2965
sbk25	0.3035	0.3035 0.2965 sbk26 0.3	0.3075	0.3035	sbk27	0.3060	0.2910	
	0.2995	0.2895		0.3035	0.2965		0.3020	0.2840
	0.3035	0.2965						
able 20	0.3075	0.3035						
sbk28	0.3100	0.2980						
	0.3060	0.2910						

Note: Chromaticity coordinate groups are measured with an accuracy of ±0.005.

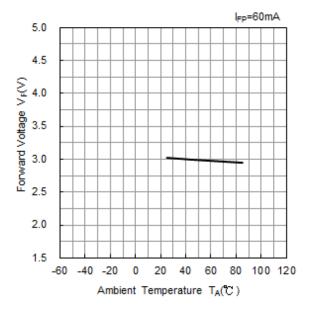


Optical and electrical characteristics

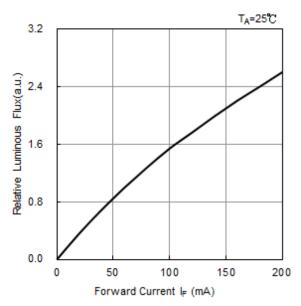
Forward Voltage vs. Forward Current



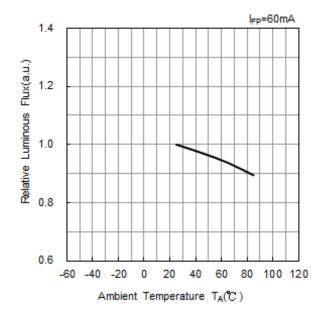
Ambient Temperature vs. Forward Voltage



Forward Current vs. Relative Luminous Flux

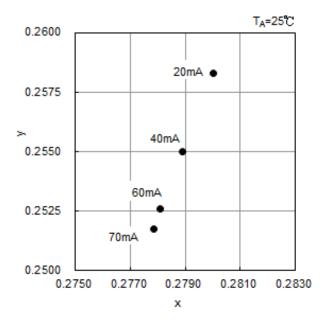


Ambient Temperature vs. Relative Luminous

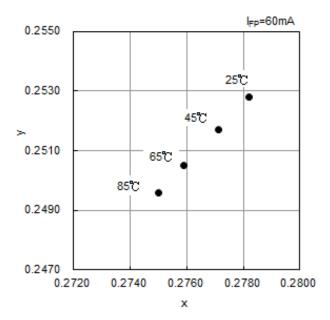




Forward Current vs.Chromaticity Coordinate

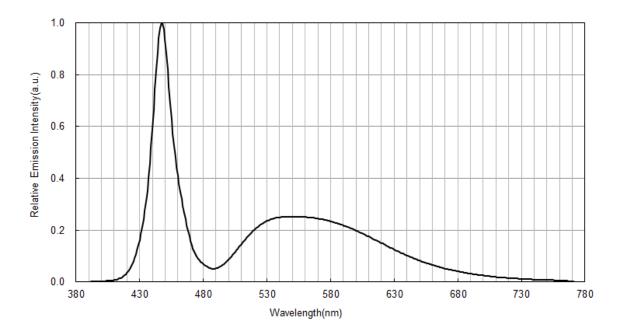


Ambient Temperature vs. Chromaticity Coordinate

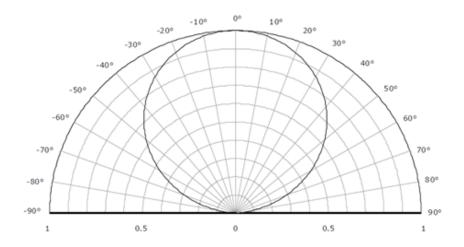




Spectrum(T_A=25[°]C,I_{FP}=60mA)



Radiation Pattern(T_A=25°C,I_{FP}=60mA)





Recommended Reflow Soldering Conditions

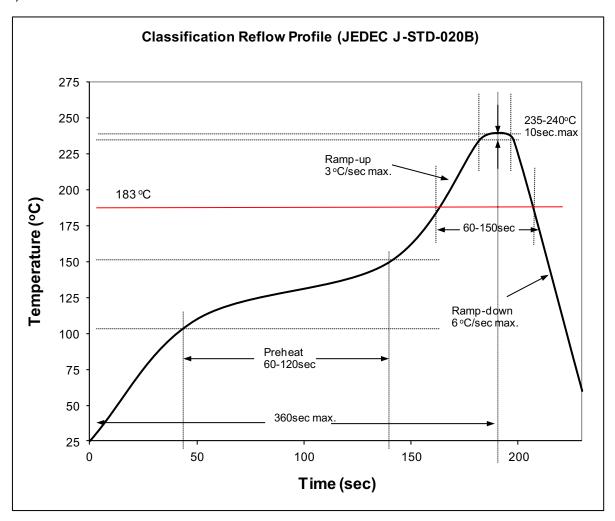
Surface Mounting Condition

In automatic mounting of the SMD LEDs on printed circuit boards, any bending, expanding and pulling forces or shock against the SMD LEDs should be kept min. to prevent them from electrical failures and mechanical damages of the devices.

Soldering Reflow

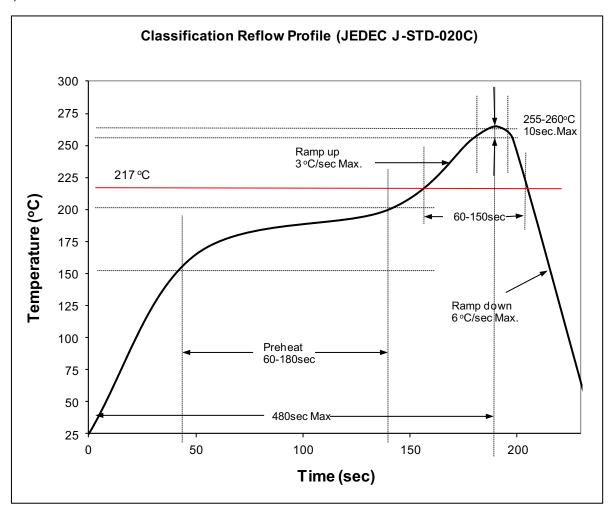
- -Soldering of the SMD LEDs should conform to the soldering condition in the individual specifications.
- -SMD LEDs are designed for Reflow Soldering.
- -In the reflow soldering, too high temperature and too large temperature gradient such as rapid heating/cooling may cause electrical & optical failures and damages of the devices.
- -AOT cannot guarantee the LEDs after they have been assembled using the solder dipping method.

1) Lead Solder





2) Lead-Free Solder

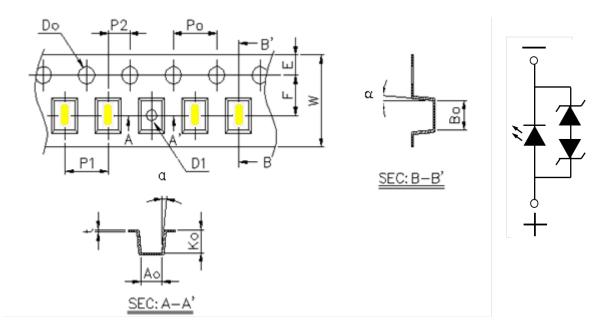


3) Manual Soldering Conditions

- Lead Solder
 - Max. 300 °C for Max. 3sec, and only one time.
- Lead-free Solder
 - Max. 350 °C for Max. 3sec, and only one time.
- There is possibility that the brightness of LEDs is decreased, which is influenced by heat or ambient atmosphere during reflow. It is recommended to use the nitrogen reflow method.
- After LEDs have been soldered, repair should not be done. As repair is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will be damaged by repairing or not.
- Reflow soldering should not be done more than two times.

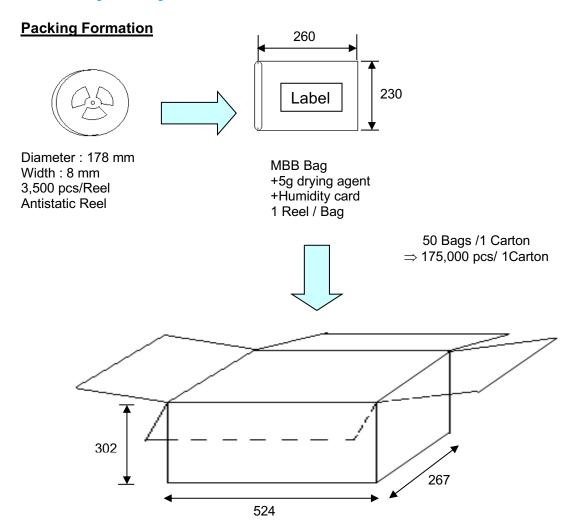


<u>Dimensions (Unit :mm)</u> Quantity: 3,500 pcs/reel

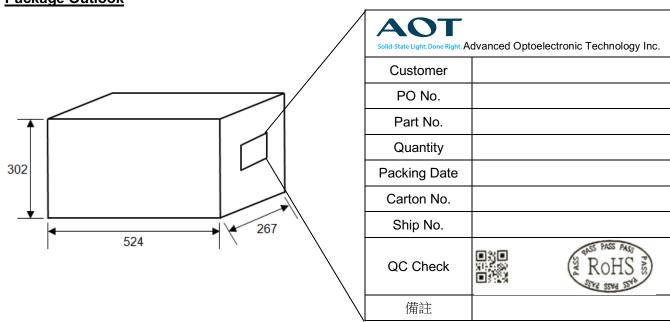


Item	Spec.	Tolerance(mm)	Item	Spec.	Tolerance(mm)
W	8.00	±0.10	P2	2.00	±0.05
Е	1.75	±0.10	t	0.25	±0.02
F	3.50	±0.05	A0	1.53	±0.10
D0	1.50	+0.10	В0	3.20	±0.10
D1	0.72	±0.10	K0	0.72	±0.10
P0	4.00	±0.10			





Package Outlook





Reel Label Definition

SAP. No.

SMD LED

Part Number : XXXXX-XXXX

Brightness : A
CIE : B
VF : C
Quantity : nn ea

Serial No : SM0yymmddxxxx

Seriai No : Siviuyymmaaxxxx

Cust. PN. : XXXXX-XXXX



A: Iv value.

B : CIE value noted

C: Vf value.

nn: Quantity of LED

SM0yymmddxxx: yy: year, mm: month, dd: day, xxxx: reel no.

*Reel Label to fill in practice data of all LED characteristic



Reliability Test

No.	Test Item	Standard Test Test		Note	Number of
		Method	Conditions		Damaged
1	Room Temp. Life Test	Internal Ref.	T _A =25 °C,I _F =60mA	1000 hr	0/20
2	High Temp. Operation	JESD22-A108	T _A =65°C,I _F =60mA	1000 hr	0/20
3	High Temp. Operation	JESD22-A108	T _A =85°C,I _F =60mA	1000 hr	0/20
4	High Temp. Storage	JESD22-A103	T _A =100°C	1000 hr	0/20
5	Low Temp. Operation	JESD22-A108	T _A =-40°C,I _F =60mA	1000 hr	0/20
6	High Temp. and High Humidity Operation	JESD22-A119	60°C 90%RH,I _F =60mA	1000 hr	0/20
7	Temperature and humidity cycle test	IEC68-2-38	25°C ~65°C ~-10°C,90% RH 24hr per cycle	10 cycle	0/20
8	Thermal Cycling Test	JESD22-A106	-40°C ~ 100°C ,30min Transform time 5min	300 cycles	0/50

Criteria for Judging Damage

Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	V _F	I _F =60mA	-	*U.S.L×1.1
Luminous Flux	Ф٧	I _F =60mA	*L.S.L×0.9	-

* U.S.L: Upper Standard Level

* L.S.L: Lower Standard Level

Thermal Test Condition

Light Bar Thermal Test Condition							
PKG Model	PCB Temperature (°C)	Test Current (mA)	Test Time (s)	Judgment			
3014M-W3M2	120±10	60±1	10	No LED OFF			

SMT must be done Thermal Test Condition

PCB Temperature must reach 110°C for 5 seconds



Cautions

(1) Moisture Proof Package

The moisture proof package should be used to prevent moisture in the package as the moisture may Cause damage to optical characteristics of the LEDs.

The aluminum bag with zipper is used for moisture proof package. And, the moisture absorbent Material, Silica gel, is inserted into aluminum bag.

(2) Storage:

Storage Conditions

Before opening the package:

The LEDs should be kept at 30°C or less than 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material is recommended. After opening the package:

After open the package, the LED should be kept at 30°C, 60%RH or less. The LED should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, it should be stored in moisture proof condition.

(3) Heat Generation

Thermal design of the end products is of paramount importance. The heat generation must be taken into design consideration when using the LED. The coefficient of the temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components.

(4) Static Electricity

Static electricity or surge voltage damages the LEDs. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LEDs. When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a Vf test at a lower current. (Below 1mA is recommended). Criteria: $V_F > 1.9V$ at $I_F = 1 \mu$ A

(5) Cleaning

Use isopropyl alcohol as a solvent for cleaning the LEDs. The other solvent may dissolve the LEDs package and the epoxy.

Ultrasonic cleaning should not be done.

(6) Electrostatic Discharge (ESD)

The products are sensitive to static electricity or surge voltage, An ESD event may damage its die or reduce its reliability performance. When handling the products, measures against electro static discharge, including the followings, are strongly recommended.

Eliminating the charge;



Wrist strap, ESD footwear and garments, ESD floors

Grounding the equipment and tools at workstation

ESD table / shelf mat (conductive materials)

Proper grounding techniques are required for all devices, equipment and machinery used in the assembly of the products, Also note that surge protection should be considered in the design of customer products.

If tools or equipment contain insulating materials, such as glass or plastic, proper measures against electro static discharge, including the followings are strongly recommended.

Dissipating the charge with conductive materials

Preventing the charge generation with moisture

Neutralizing the charge with ionizer

(7) Others

When using the LEDs, it must care that the reverse voltage will not exceed the absolute maximum rating. The LED light is enough to injure human eyes, so it should avoid looking at LED light directly.

NOTE.

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